

### DDR4 DIMM TE Internal #: 2309412-1 Small Outline (SO), Stack Height 8 mm [.315 in], Right Angle Module Orientation, 260 Position, DDR4 DIMM, SO DIMM Sockets View on TE.com >



Connectors > Socket Connectors > Memory Sockets > SO DIMM Sockets > DDR4 SO DIMM Sockets



# DRAM Type: Small Outline (SO) Stack Height: 8 mm [.315 in ]

Module Orientation: Right Angle

Number of Positions: 260

Centerline (Pitch): .5 mm, 5.4 mm, 6.1 mm [.02 in ]

All DDR4 SO DIMM Sockets (39)

#### Features

#### Product Type Features

Connector System

Connector & Contact Terminates To

Cable-to-Board

Printed Circuit Board

Connector & Contact Terminates To	Printed Circuit Board
DRAM Type	Small Outline (SO)
Configuration Features	
Number of Keys	1
Number of Rows	2
Module Orientation	Right Angle
Number of Positions	260
Electrical Characteristics	
DRAM Voltage	1.2 V
Signal Characteristics	
SGRAM Voltage	1.2 V
Body Features	
Ejector Location	Both Ends
Retention Post Material	Stainless Steel
Latch Material	High Temperature Thermoplastic

Small Outline (SO), Stack Height 8 mm [.315 in], Right Angle Module Orientation, 260 Position, DDR4 DIMM, SO DIMM Sockets



Retention Post Location	Both Ends
Module Key Type	Offset Right
Ejector Type	Locking
Connector Profile	High
Contact Features	
Memory Socket Type	Memory Card
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Gold Flash
Contact Base Material	Copper Alloy
Contact Current Rating (Max)	.5 A
Contact Mating Area Plating Material	Gold Flash
Termination Features	
Insertion Style	Cam-In
Termination Method to PCB	Surface Mount
Mechanical Attachment	
Mating Alignment Type	Reverse Keying
PCB Mount Retention	With
PCB Mount Retention Type	Solder Peg
Connector Mounting Type	Board Mount
Housing Features	
Housing Material	High Temperature Thermoplastic
Housing Color	Black
Centerline (Pitch)	.5 mm, 5.4 mm, 6.1 mm[.02 in]
Dimensions	
Stack Height	8 mm[.315 in]
Row-to-Row Spacing	8.2 mm[.322 in]
Usage Conditions	
Operating Temperature Range	-55 – 85 °C[-67 – 185 °F]
Operation/Application	
Circuit Application	Power
Industry Standards	
UL Flammability Rating	UL 94V-0

Small Outline (SO), Stack Height 8 mm [.315 in], Right Angle Module Orientation, 260 Position, DDR4 DIMM, SO DIMM Sockets



#### Packaging Features

Packaging Quantity	500
Packaging Method	Tape & Reel

#### Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JUNE 2024 (241) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Reflow solder capable to 260°C

Product Compliance Disclaimer

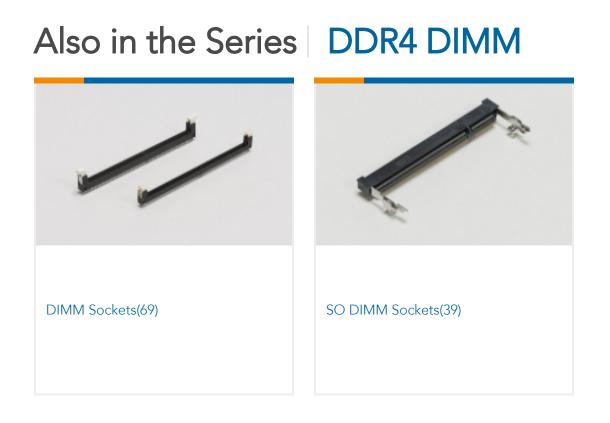
This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

## **Compatible Parts**



Small Outline (SO), Stack Height 8 mm [.315 in], Right Angle Module Orientation, 260 Position, DDR4 DIMM, SO DIMM Sockets





# Customers Also Bought



		_ 11_	-= / _	
TE Part #2007254-1 SFP+ 1x1 Cage Assembly, Light Pipe	TE Part #1-66358-3 III+ SKT,18-14,30AU/FL,STRIP	TE Part #2213775-7 AV16 SPM 0.4VA POWER LED GREEN 12V	TE Part #2118707-4 1 PC STD SHIELD, AL-16.50X16.50X3. 60MM	



### Documents

Product Drawings DDR4 SODIMM 260P 8.0H RVS

English

#### **CAD** Files

3D PDF

3D

Small Outline (SO), Stack Height 8 mm [.315 in], Right Angle Module Orientation, 260 Position, DDR4 DIMM, SO DIMM Sockets



Customer View Model

ENG\_CVM\_CVM\_2309412-1\_1.2d\_dxf.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_2309412-1\_1.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_2309412-1\_1.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications Application Specification

English